



PLA172P 800V Normally-Open Single-Pole 6-Pin OptoMOS[®] Relay

| Parameter | Rating | Units |
|-----------------------|--------|-------------------|
| Load Voltage | 800 | V _P |
| Load Current | 100 | mA _{rms} |
| | 85 | mA _{DC} |
| On-Resistance (max) | 50 | Ω |
| Input Control Current | 2 | mA |

Features

- Guaranteed Specifications at 105°C
- -40°C to +105°C Operational Temperature Range
- 5mA Input Control Current Over Operating Temperature Range
- 800V_P Blocking Voltage
- · 6.8mm Pad-to-Pad Separation of Output Pins
- 5000V_{rms} Input/Output Isolation
- Small Surface Mount Package
- Arc-Free With No Snubbing Circuits
- No EMI/RFI Generation
- Flammability Rating UL 94 V-0

Applications

- Industrial Controls
- Instrumentation
- Multiplexers
- Data Acquisition
- Electronic Switching
- I/O Subsystems
- Meters (Watt-Hour, Water, Gas)
- Medical Equipment—Patient/Equipment Isolation

Description

IXYS Integrated Circuits' PLA172P is a single-pole, normally-open (1-Form-A) Solid State Relay, rated for operation up to 105°C, that uses optically coupled MOSFET technology to provide an enhanced input to output isolation of 5000V_{rms}.

The unique device pinout provides more than 6.8mm of pad-to-pad separation between the high voltage output pins.

Control of the optically coupled output is by the input infrared LED. The PLA172P is designed to replace electromechanical relays, and provides bounce-free switching in a compact, surface-mount package.

Approvals

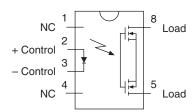
- UL Approval Pending
- EN/IEC 60950-1 Approval Pending

Ordering Information

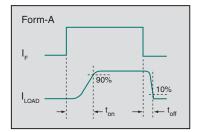
| Part # | Description |
|-----------|--|
| PLA172P | 6-Pin (8-Pin Body) Flatpack (50/Tube) |
| PLA172PTR | 6-Pin (8-Pin Body) Flatpack, Tape & Reel (1000/Reel) |

Pin Configuration

AC/DC Configuration



Switching Characteristics of Normally-Open Devices







Absolute Maximum Ratings (@ 25°C Unless otherwise noted)

| Parameter | Ratings | Units | |
|---|-------------|------------------|--|
| Blocking Voltage (-40°C to +105°C) | 800 | V _P | |
| Reverse Input Voltage | 5 | V | |
| Input Control Current | 50 | mA | |
| Peak (10ms) | 1 | А | |
| Input Power Dissipation ¹ | 150 | mW | |
| Output Power Dissipation | | | |
| AC Load Current ² | 890 | mW | |
| DC Load Current ³ | 667 | | |
| Isolation Voltage, Input to Output (60 Seconds) | 5000 | V _{rms} | |
| Operational Temperature | -40 to +105 | °C | |
| Storage Temperature | -40 to +125 | °C | |
| Derate linearly 1.22 mW / °C | | | |

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

Typical values are characteristic of the device at the specified temperatures and are the result of engineering evaluations. They are provided for information purposes only and are not part of the manufacturing testing requirements.

¹ Derate linearly 1.33 mW / °C

² Derate linearly 8.9 mW / °C

³ Derate linearly 6.67 mW / °C

Electrical Characteristics

| Parameter | Conditions | Symbol | Min | Тур | Max | Units |
|--|--|-------------------|------|------|------|-------------------|
| Output Characteristics @ 25 | °C | | | | | |
| Load Current | I _⊨ =2mA | | | | | |
| AC ¹ | 0 anti- | | - | - | 100 | mA _{rms} |
| DC ² | Continuous | L L | - | - | 85 | mA _{DC} |
| Peak | t=10ms | I _{LPK} | - | - | ±350 | mA _P |
| On-Resistance ³ | L=2mA $L=100mA$ | | - | 37 | 50 | • |
| | I _F =2mA, I _L =1mA | R _{ON} | - | 57 | 85 | Ω |
| Off-State Leakage Current | V _L =800V _P | I _{LEAK} | - | - | 1 | μΑ |
| Switching Speeds | | | | | | |
| Turn-On | | t _{on} | - | 1.2 | 5 | |
| Turn-Off | I _F =5mA, I _L =100mA | t _{off} | - | 0.5 | 5 | ms |
| Output Capacitance | I _F =0mA, V _L =20V, f=1MHz | C _{OUT} | - | 10 | - | pF |
| Output Characteristics @ 10 | 5°C | | | | | |
| On-Resistance ³ | I _F =5mA, I _L =30mA | D | - | 70 | 110 | Ω |
| | I _F =5mA, I _I =1mA | R _{ON} | - | 110 | 140 | 22 |
| Off-State Leakage Current | V _L =800V _P | I _{LEAK} | - | - | 5 | μΑ |
| Switching Speeds | | | | | | |
| Turn-On | L_EmA_L_20mA | t _{on} | - | - | 10 | mo |
| Turn-Off | I _F =5mA, I _L =30mA | t _{off} | - | - | 10 | ms |
| Input Characteristics @ 25°C | | | | | | |
| Input Control Current to Activate ⁴ | I _L =100mA | l _F | - | 0.35 | 2 | mA |
| Input Control Current to Deactivate | - | I _F | 0.05 | - | - | mA |
| Input Voltage Drop | I _F =5mA | V _F | 0.9 | 1.2 | 1.5 | V |
| Reverse Input Current | V _R =5V | I _R | - | - | 10 | μA |
| Input Characteristics @ 105° | C | | | | · | |
| Input Control Current to Activate | I _L =30mA | l _F | - | - | 5 | mA |
| Common Characteristics @ 2 | 25°C | · · · · | | | · | |
| Input to Output Capacitance | V _{IO} =0V, f=1MHz | CIO | - | 1 | - | pF |

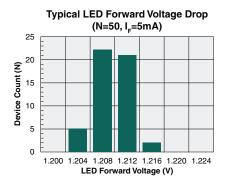
Load derates linearly from 100mA @ 25°C to 44mA @ 105°C (0.7mA/°C).
Load derates linearly from 85mA @ 25°C to 38mA @ 105°C (0.59mA/°C).
Measurement taken within 1 second of on-time.

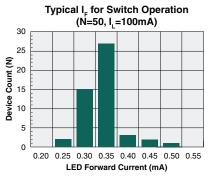
⁴ For applications requiring high temperature operation (greater than 60°C) a minimum LED drive current of 5mA is recommended.

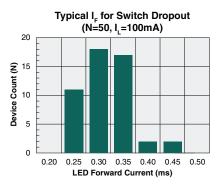


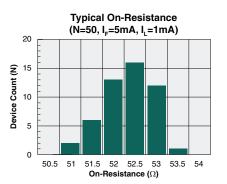
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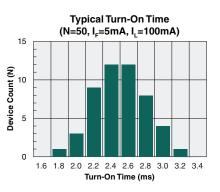
PERFORMANCE DATA*

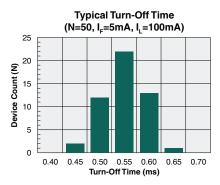


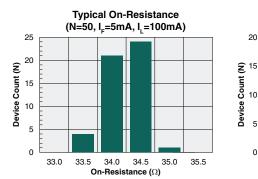


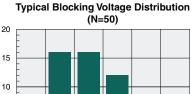


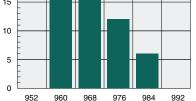




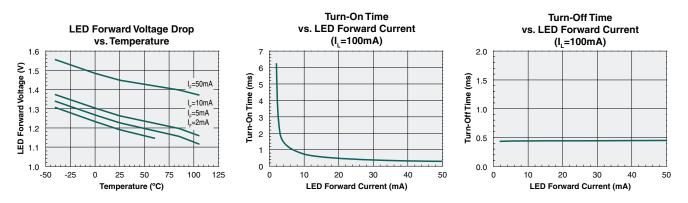










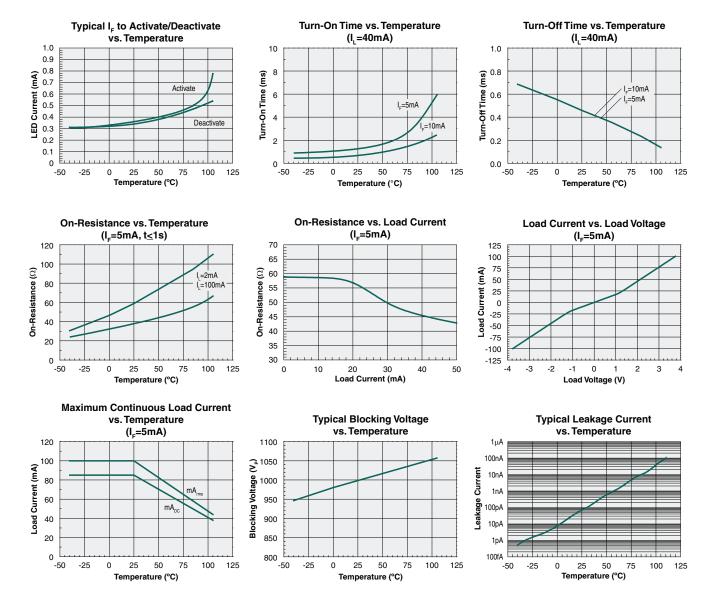


*Unless otherwise noted, data presented in these graphs is typical of device operation at 25°C. For guaranteed parameters not indicated in the written specifications, please contact our application department.



PLA172P

PERFORMANCE DATA*



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Manufacturing Information

Moisture Sensitivity

All plastic encapsulated semiconductor packages are susceptible to moisture ingression. IXYS Integrated Circuits classifies its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, **IPC/JEDEC J-STD-020**, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a Moisture Sensitivity Level (MSL) classification as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

| Device | Moisture Sensitivity Level (MSL) Classification | |
|---------|---|--|
| PLA172P | MSL 1 | |

ESD Sensitivity



This product is ESD Sensitive, and should be handled according to the industry standard JESD-625.

Soldering Profile

Provided in the table below is the Classification Temperature (T_c) of this product and the maximum dwell time the body temperature of this device may be (T_c - 5)°C or greater. The classification temperature sets the Maximum Body Temperature allowed for this device during lead-free reflow processes. For through-hole devices, and any other processes, the guidelines of **J-STD-020** must be observed.

| Device | Classification Temperature (T _c) | Dwell Time (t _p) | Max Reflow Cycles |
|---------|--|------------------------------|-------------------|
| PLA172P | 250°C | 30 seconds | 3 |

Board Wash

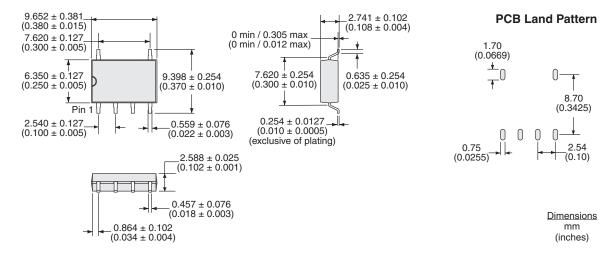
IXYS Integrated Circuits recommends the use of no-clean flux formulations. Board washing to reduce or remove flux residue following the solder reflow process is acceptable provided proper precautions are taken to prevent damage to the device. These precautions include, but are not limited to: using a low pressure wash and providing a follow up bake cycle sufficient to remove any moisture trapped within the device due to the washing process. Due to the variability of the wash parameters used to clean the board, determination of the bake temperature and duration necessary to remove the moisture trapped within the package is the responsibility of the user (assembler). Cleaning or drying methods that employ ultrasonic energy may damage the device and should not be used. Additionally, the device must not be exposed to flux or solvents that are Chlorine- or Fluorine-based.



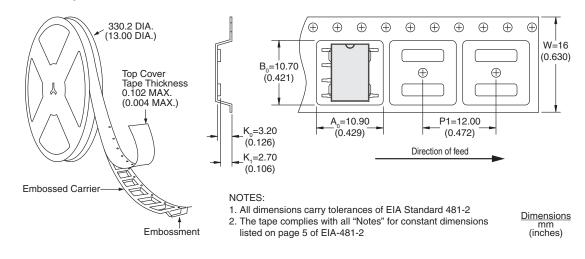


Mechanical Dimensions

PLA172P Package



PLA172PTR Tape & Reel



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